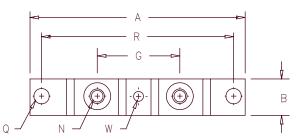
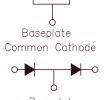
# Schottky PowerMod













copper

D=Doubler Notes: Baseplate: Nickel plated

Dim. Inches		Millimeters		
Min.	Max.	Min.	Max.	Notes
B 0.700 C E 0.120 F 0.490 G 1.375 H 0.050 N Q 0.275 R 3.150 U 0.600 V 0.312	.680 0.130 0.510 BSC  0.290 ) BSC  0.340	34.92 1.25  6.99 80.01 15.24	12.95 P BSC  7.37 BSC	1/4-20 Dia.

Microsemi	Industry	Working Peak	Repetitive Peak
Catalog Number	Part Number	Reverse Voltage	Reverse Voltage
CPT50080* CPT50090* CPT500100*	MBR50080CT MBR500100CT	80V 90V 100V	80V 90V 100V

\*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard ring protection
- 500 Amperes / 80 to 100 Volts
- 175°C junction temperature
- Reverse energy tested
- ROHS Compliant

#### Electrical Characteristics

F(AV) 500 Amps Average forward current per pkg Average forward current per leg F(AV) 250 Amps IFSM 5000 Amps Maximum surge current per leg Maximum repetitive reverse current per leg | R(OV) 2 Amps Max peak forward voltage per leg | VFM 0.90 Vol 0.90 Volts  $V_{FM}$ 0.72 Volts Max peak forward voltage per leg <sup>I</sup>RM 200 mA Max peak reverse current per leg Max peak reverse current per leg <sup>I</sup>RM 8.0 mA CJ Typical junction capacitance per leg 6400 pF

 $^{T}C$  = 122°C, Square wave,  $^{R}\Theta JC$  = 0.12°C/W  $^{T}C$  = 122°C, Square wave,  $^{R}\Theta JC$  = 0.24°C/W 8.3ms, half sine,  $\overline{J}$  = 175°C f = 1 KHZ, 25°C, 1 $\mu$ sec square wave  $\overline{J}$  = 250A: $\overline{J}$  J = 25°C TFM = 250A:TJ = 175°C VRRM,TJ = 125°C\* VRRM,TJ = 25°C

 $V_R = 5.0V, T_C = 25^{\circ}C$ 

## Thermal and Mechanical Characteristics

\*Pulse test: Pulse width 300 µsec, Duty cycle 2%

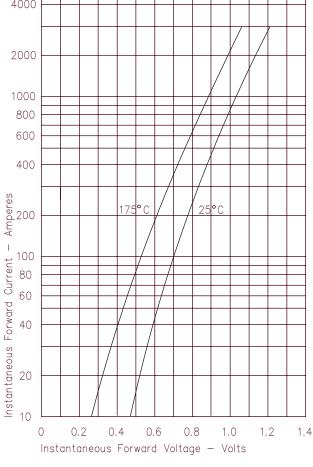
TSTG Storage temp range -55℃ to 175℃ ΤJ Operating junction temp range -55℃ to 175℃ R OJC 0.24°C/W Junction to case Max thermal resistance per leg  $\mathsf{R} \; \mathsf{\Theta} \mathsf{J} \mathsf{C}$ 0.12°C/W Max thermal resistance per pkg Junction to case R ocs 0.08°C/W Case to sink Typical thermal resistance (greased) 35-40 inch pounds Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) 30-40 inch pounds 8-10 inch pounds center hole must be torqued first 2.8 ounces (78 grams) typical Weight

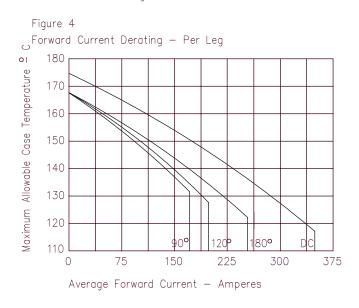


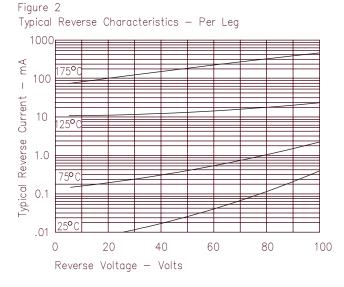
# CPT500100 CPT50080

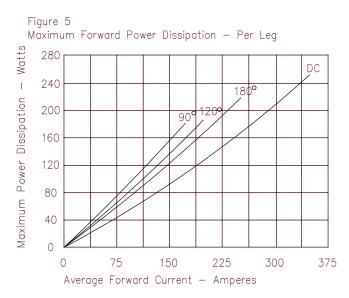
Typical Forward Characteristics - Per Leg 10,000 8000 6000 4000 2000 1000 800 600 400

Figure 3 Typical Junction Capacitance - Per Leg 100,000 60,000 40,000 20,000 Junction Capacitance 10,000 6000 4000 2000 1000 0.1 0.5 1.0 5.0 10 50 100 Reverse Voltage - Volts



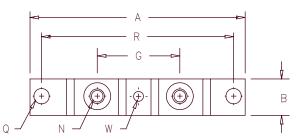








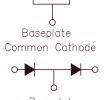
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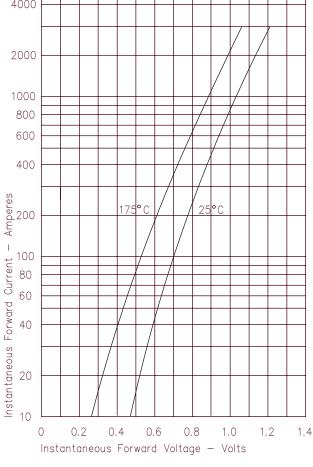
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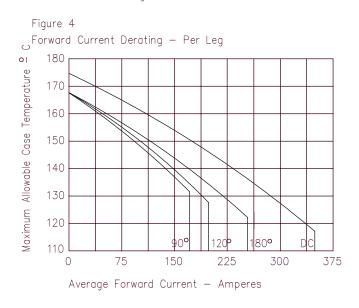


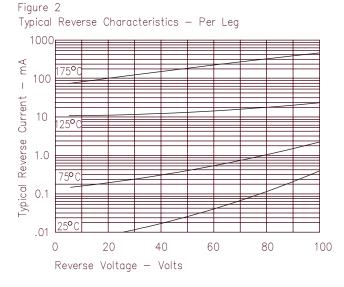
# CPT500100 CPT50080

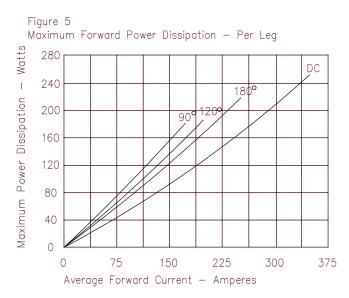
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